508018409 07/19/2023

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MENG-SHENG CHANG	06/09/2020
CHIEN-YING CHEN	06/09/2020
CHIA-EN HUANG	09/09/2020
YIH WANG	06/09/2020

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18346700

CORRESPONDENCE DATA

Fax Number: (703)518-5499

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036841111 Email: tsmc@ipfirm.com **Correspondent Name:** HAUPTMAN HAM, LLP

Address Line 1: 2318 MILL ROAD, SUITE 1400 Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	T5057-1477UB
NAME OF SUBMITTER:	RANDY A. NORANBROCK
SIGNATURE:	/Randy A. Noranbrock/
DATE SIGNED:	07/19/2023

Total Attachments: 1

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PATENT REEL: 064311 FRAME: 0048

508018409



Docket No. T5057-1477U P20193736US01

NR 27334-0-05-83

ASSIGNMENT

In consideration of the premises and other g	ood and valuable consideration	in hand paid,	the receipt and	i sufficiency of
which is hereby acknowledged, the undersigned,		•	•	•

1) Meng-Sheng CHANG 3) Chia-En HUANG

Chien-Ying CHEN 21

RECORDED: 07/19/2023

Yih WANG \$

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI. Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C. and

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

INTEGRATED CIRCUIT LAYOUT, METHOD, STRUCTURE, AND SYSTEM

(a)	for which an application for United States Letters Patent was filed on $2020-09-18$, and identified by United States Patent Application No. $17/025,563$; or
(p)	for which an application for United States Letters Patent was executed on,
	undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and

all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall bereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature: 149/6/9 Date: 1) WAIN Short CHAINS
Name: Meng-Skieng CHANG 2) (h) in This Chile.
Name: Chien-Ying CHEM 3) Chia In Huan/ Name: Chia-En HUANG 4) Same: Vib WANG

PATENT REEL: 064311 FRAME: 0049